Kinetis MKW35A/MKW36A/MKW35Z/MKW36Z Bluetooth® Low Energy Software

Quick Start Guide

Introduction

This document is a brief description of the NXP Bluetooth® Low Energy Software for the MKW35A/MKW36A/MKW35Z/MKW36Z wireless microcontroller platforms, version 1.3.2. This software package is built using the Kinetis Software Development Kit (KSDK) version 2.2. This document covers hardware setup, build and usage of the provided demo applications.

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1 Installing the Connectivity Package

This section details the steps to install the connectivity package.

First, configure and download the package archive from the staging system on the https://mcuxpresso.nxp.com website or simply download the pre-created package archive if it is available on the same website.

Unpack the contents of the archive to a folder on the local disk.

NOTE

It is recommended to use the default location for the package (C:\NXP) and create a subfolder there specific to each device and release.

2 Building the Binaries

This section details the required steps for creating the binary files to be downloaded to the boards.

NOTE

To be able to build any of the demo applications you need one of the following toolchains:

- IAR Embedded Workbench for ARM® (version 8.11.3 or higher)
- MCUXpresso IDE (version 10.1.1 606 or higher)

This connectivity software package does not include support for any other toolchains.

The packages must be built with the debug configuration to enable debugging information.

This package includes various demo applications that can be used as a starting point.

The next section presents the steps required for building the *heart_rate_sensor* application. All applications can be found using the following placeholders for text:

- <connectivity path>: represents the root path for the SDK.
- <RTOS>: represents the scheduler or RTOS used by the app; it can be either "bm" or "freertos"
- <demo app>: represents the demo app name
- <IDE>: represents the integrated development environment used to build projects and can be "iar".

The demo applications general folder structure is the following:

Kinetis Bluetooth Low Energy Software Demo Application Build Example

Selected app: heart rate sensor

Board: frdmkw36 RTOS: FreeRTOS Resulting location:

NOTE

If your FRDM-KW36 board is configured for the buck or boost modes of the KW36Z DCDC converter, please note that the following defines need to be set: $gDCDC_Enabled_d$ to 1 and APP_DCDC_MODE to $gDCDC_Mode_Buck_c$ or $gDCDC_Mode_Boost_c$ respectively, in the app_preinclude.h header file.

The Heart Rate sensor application is configured for low power operation by default. In this case, when the core enters in sleep mode, the debug probe will fail. If you want to disable the low power functionality, the *cPWR_UsePowerDownMode* preprocessor definition needs to be set to 0 in the app preinclude.h header file.

2.1 Building and Flashing the BLE Software Demo Applications using IAR

Step 1:

Navigate to the resulting location in the SDK root directory.

Step 2:

Open the highlighted IAR workspace file (*.eww file format):

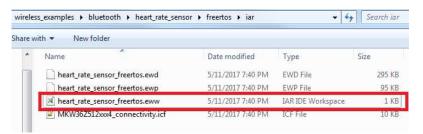


Figure 1: "Heart Rate Sensor" IAR demo project location

Step 3:

Select the Heart Rate Sensor project.

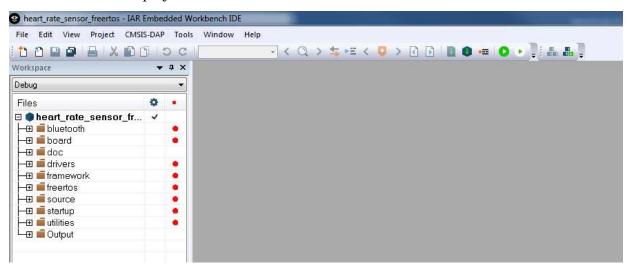


Figure 2: Heart Rate Sensor FreeRTOS IAR project

Step 4:

Build the Heart Rate Sensor project.

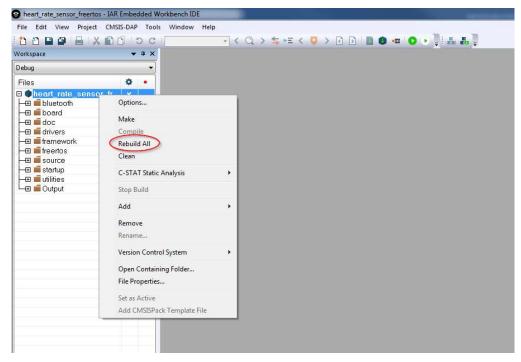


Figure 3: Heart Rate Sensor build

Step 5

Make the appropriate debugger settings in the project options window:

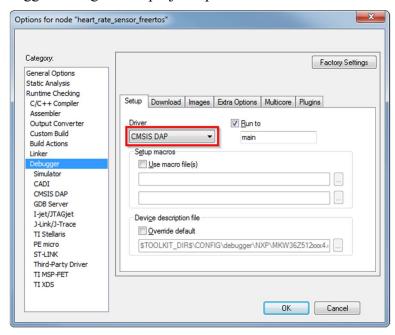


Figure 4: Debugger Settings

Step 6:

Click the "Download and Debug" button to flash the executable onto the board.

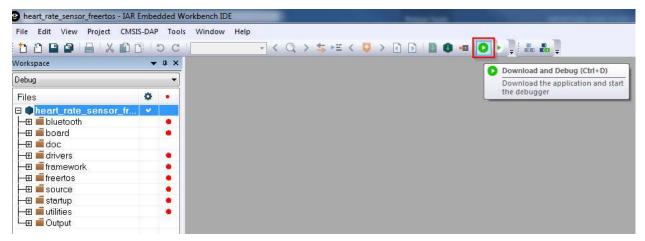


Figure 5: Heart Rate Sensor Download and Debug

NOTE

The projects are configured to use "CMSIS DAP" as the default debugger. Please make sure that your board's OpenSDA chip contains a CMSIS DAP firmware or that the debugger selection corresponds to the physical interface used to interface to the board. See the section below for more information.

2.2 Building and Flashing the BLE Software Demo Applications using MCUXpresso IDE

Step 1:

Open MCUXpresso IDE and open an existing or new workspace location.

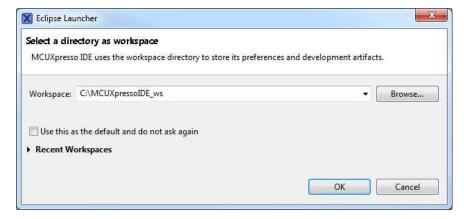


Figure 6: Select a MCUXpresso IDE workspace location

Step 2:

Right click in the "Installed SDKs" tab and then click "Import Folder".

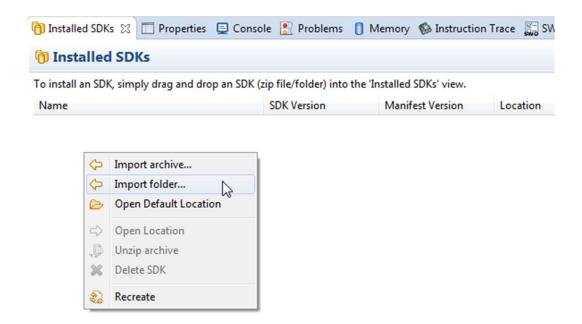


Figure 7: Import a new SDK from a folder

When the Browse dialog appears, go to the location of the unpacked archive and select the folder. The SDK will be imported.

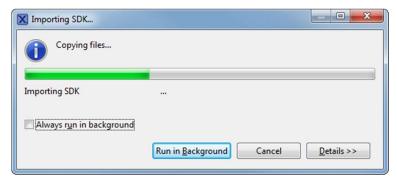


Figure 8: Importing the SDK

Step 3:

After the SDK is loaded successfully elect the Import the SDK examples(s)..." option to add examples to your workspace.

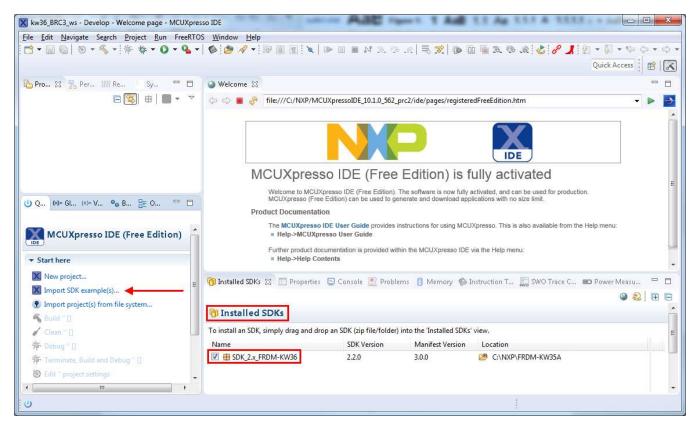


Figure 9: Installed SDKs

Step 4:

Select the board, then the desired example(s):

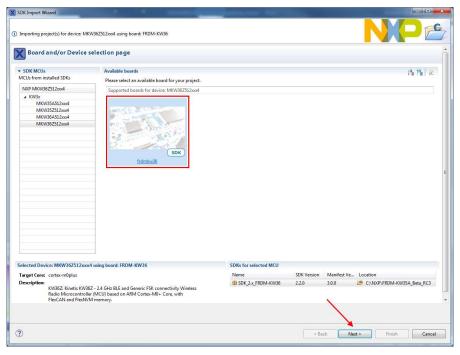


Figure 10: Select the board

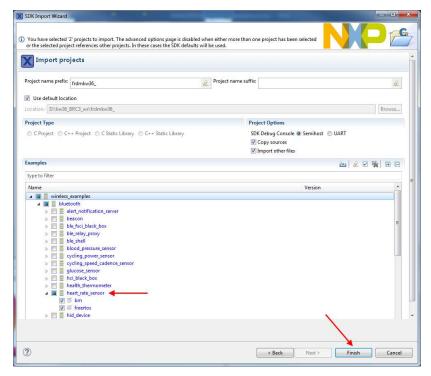


Figure 11: Select the example(s)

Step 5:

Build the heart_rate_sensor project.

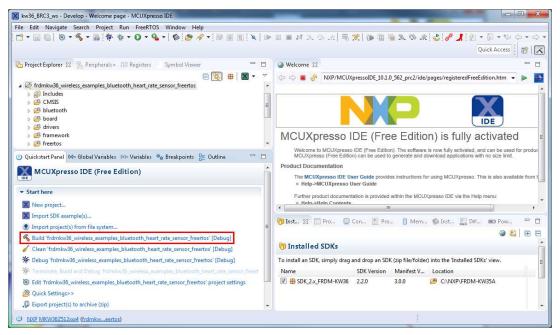


Figure 12: Build the "heart_rate_sensor" FreeRTOS project

Step 6:

Click the "Debug" button to download the executable onto the board.



Figure 13: Download and debug the "heart_rate_sensor" FreeRTOS project

3 Hardware Setup

The hardware setup in this example uses a FRDM-KW36 development platform, shown in the figure below:



Figure 14: FRDM-KW36

The FRDM-KW36 board should have the OpenSDA USB port connected to a Windows PC. The OpenSDA chip on the board should have appropriate firmware flashed, with debugging and virtual serial COM port capabilities. For more information on OpenSDA please refer to the following webpage: www.nxp.com/opensda.

Variants of embedded firmware for the OpenSDA chip can be downloaded from:

https://github.com/mbedmicro/CMSIS-DAP https://www.segger.com/opensda.html

CMSIS DAP is the default interface selected in the IAR Embedded Workbench for ARM® projects with FRDM-KW36 included in this release.

The FRDM-KW36 board can be configured via jumpers to be in the two modes of the DCDC converter inside the KW36Z microcontroller or to bypass it entirely, as shown in the figure below:

Power Configuration

Default: Buck Mode (auto start).

	PSW_CFG J38	REG_CFG J27, J30
Bypass Mode (auto start) VDCDC_IN (1.71 to 3.6V) Operation 1.8V - 3.6 V	1~2	J27-on J30-on
Buck Mode (manual start) VDCDC_IN (1.8V to 4.2V) Coin Cell Battery Operation	1~2 press SW4 to start	J27-off J30-off
Buck Mode (auto start) VDCDC_IN (1.8V to 4.2V) Coin Cell Battery Operation	2~3	J27-off J30-off

Figure 15: FRDM-KW36 Jumper Configuration for DCDC Modes

4 Running the Heart Rate sensor application using *IoT Toolbox* mobile application

This section does not cover the installation of the *IoT Toolbox* mobile application and it assumes you have already installed the latest version from the application store.

Step 1:

Flash the board with the Heart Rate sensor application as previously described. If low power support is enabled, no LED's will be flashing.

Step 2:

Make sure your phone's Bluetooth Device is enabled.

Step 3:

Open the IoT Toolbox application and select the Heart Rate icon.



Figure 16: Kinetis BLE Toolbox - opening Heart Rate application

Step 4:

Press **SW2** on the FRDM-KW36 board to start advertising. The device should become visible for the Heart Rate application.





Figure 17: Selecting the scanned device

Step 5:

Select the device that appears in the *Heart Rate* tab to connect to it. After connecting, the mobile application starts plotting the randomly generated heart rate values sent by the FRDM-KW36 device.

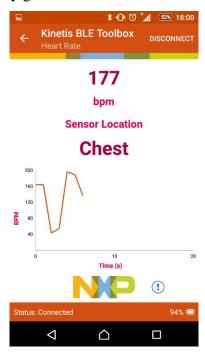


Figure 18: Heart Rate sensor device functionality in connected mode

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Document Number: MKW35ABLESW132QSG

Rev. 1 04/2018

